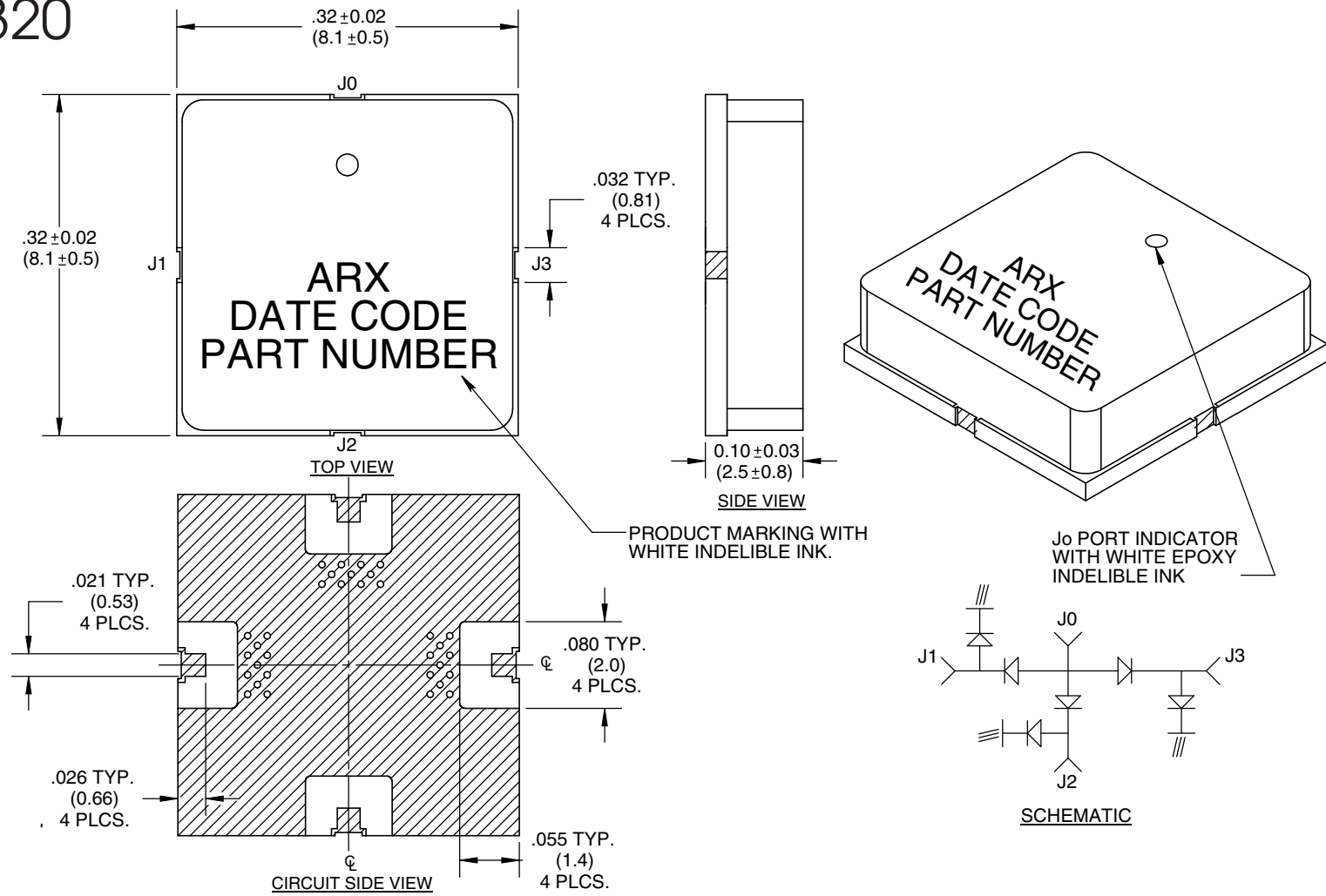


# CS320



- NOTES:  
 1. SUBSTRATE MATERIAL: 20 MIL THICK ALUMINA NITRIDE (ALN) RF COVER: BLACK CERAMIC.  
 2. TOP SIDE AND BACKSIDE METALLIZATION: 40 $\mu$  IN PLATED Au, 60 $\mu$  IN PLATED Ni OVER Ti-Pd-Au.  
 3. DIMENSION IN PARENTHESIS ARE IN MM.